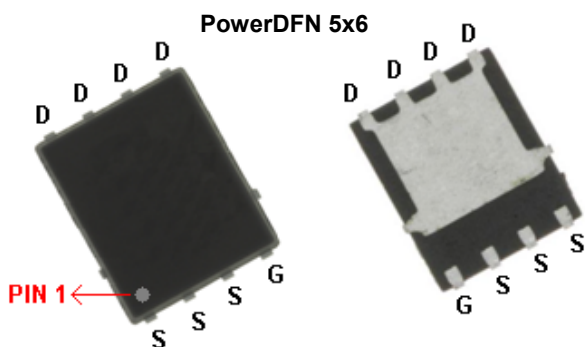


N-Channel 30V (D-S) MOSFET

GENERAL DESCRIPTION

The ME7356-G is the N-Channel logic enhancement mode power field effect transistors are produced using high cell density , DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management and other battery powered circuits where Low-side switching , and low in-line power loss are needed in a very small outline surface mount package.

PIN CONFIGURATION



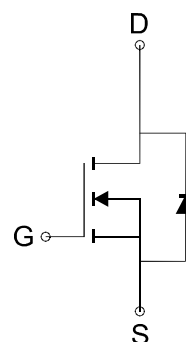
Ordering Information: ME7356-G (Green product-Halogen free)

FEATURES

- $R_{DS(ON)} \leq 5m\Omega @ V_{GS}=10V$
- $R_{DS(ON)} \leq 6.2m\Omega @ V_{GS}=4.5V$
- Super high density cell design for extremely low $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability

APPLICATIONS

- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch



N-Channel MOSFET

Absolute Maximum Ratings ($T_A=25^\circ\text{C}$ Unless Otherwise Noted)

Parameter		Symbol	Maximum Ratings	Unit
Drain-Source Voltage		V_{DS}	30	V
Gate-Source Voltage		V_{GS}	± 20	V
Continuous Drain Current*	$T_A=25^\circ\text{C}$	I_D	18.6	A
	$T_A=70^\circ\text{C}$		14.9	
Pulsed Drain Current		I_{DM}	75	A
Maximum Power Dissipation*	$T_A=25^\circ\text{C}$	P_D	2.8	W
	$T_A=70^\circ\text{C}$		1.8	
Operating Junction Temperature		T_J	150	$^\circ\text{C}$
Storage Temperature Range		T_{stg}	-55 to 150	$^\circ\text{C}$
Thermal Resistance-Junction to Ambient*		$R_{\theta JA}$	45	$^\circ\text{C/W}$

*The device mounted on 1in² FR4 board with 2 oz copper

DCC
正式發行

N-Channel 30V (D-S) MOSFET

Electrical Characteristics (TA=25°C Unless Otherwise Specified)

Symbol	Parameter	Limit	Min	Typ	Max	Unit
STATIC						
V(BR)DSS	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250 μA	30			V
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250 μA	1.2		3.0	V
I _{GSS}	Gate Leakage Current	V _{DS} =0V, V _{GS} =±20V			±100	nA
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =24V, V _{GS} =0V			1	μA
R _{DS(ON)}	Drain-Source On-State Resistance ^a	V _{GS} =10V, I _D =18A		4.2	5	mΩ
		V _{GS} =4.5V, I _D =16A		5.4	6.2	
V _{SD}	Diode Forward Voltage	I _S =18A, V _{GS} =0V		0.8	1.2	V
DYNAMIC						
Q _g	Total Gate Charge	V _{DS} =15V, V _{GS} =10V, I _D =18A		54.3		nC
Q _g	Total Gate Charge	V _{DS} =15V, V _{GS} =4.5V, I _D =18A		27		
Q _{gs}	Gate-Source Charge			10.9		
Q _{gd}	Gate-Drain Charge			13.6		
C _{iss}	Input Capacitance	V _{DS} =15V, V _{GS} =0V, F=1MHz		2732		pF
C _{oss}	Output Capacitance			339		
C _{rss}	Reverse Transfer Capacitance			258		
R _g	Gate-Resistance	V _{DS} =0V, V _{GS} =0V, F=1MHz		1.7		Ω
t _{d(on)}	Turn-On Delay Time	V _{DD} =15V, R _L =1Ω V _{GEN} =10V, R _G =6Ω I _D =18A		24.8		ns
t _r	Turn-On Rise Time			128		
t _{d(off)}	Turn-Off Delay Time			77.2		
t _f	Turn-Off Fall Time			18.5		

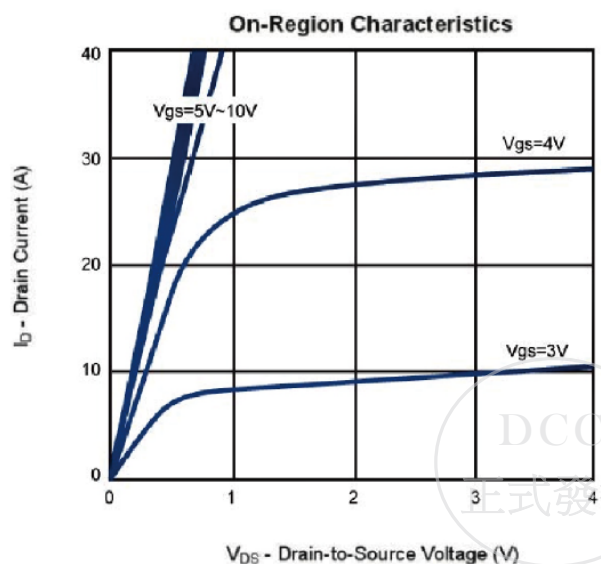
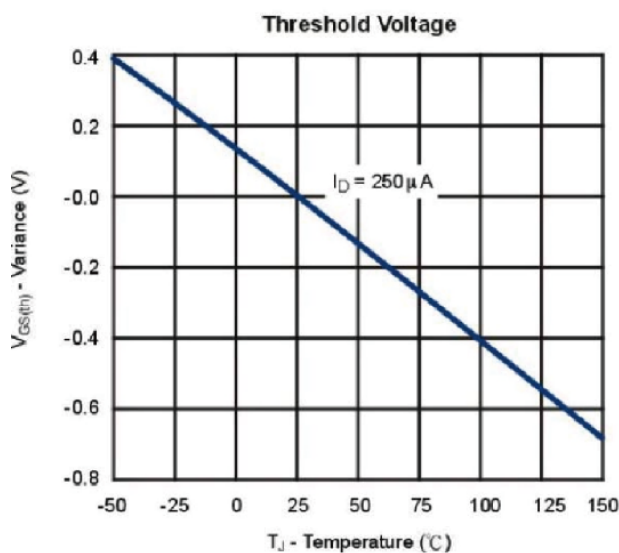
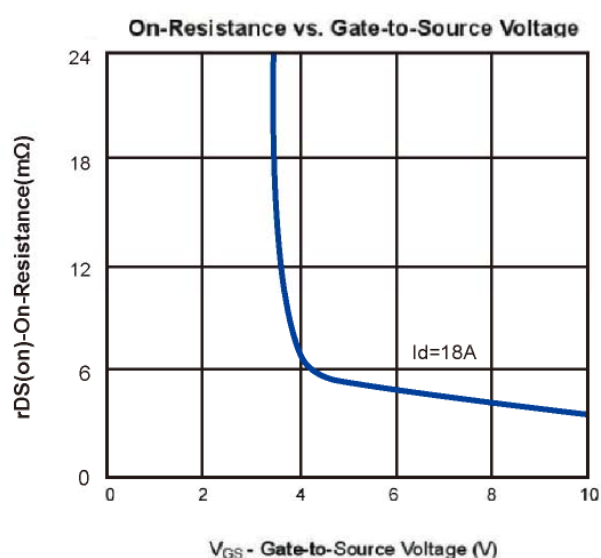
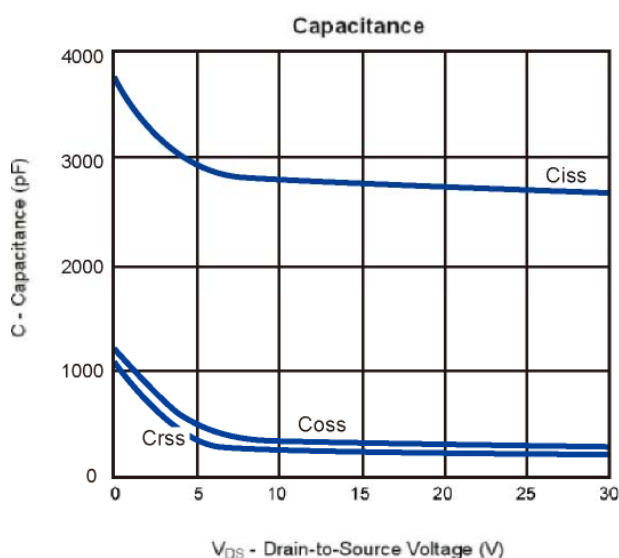
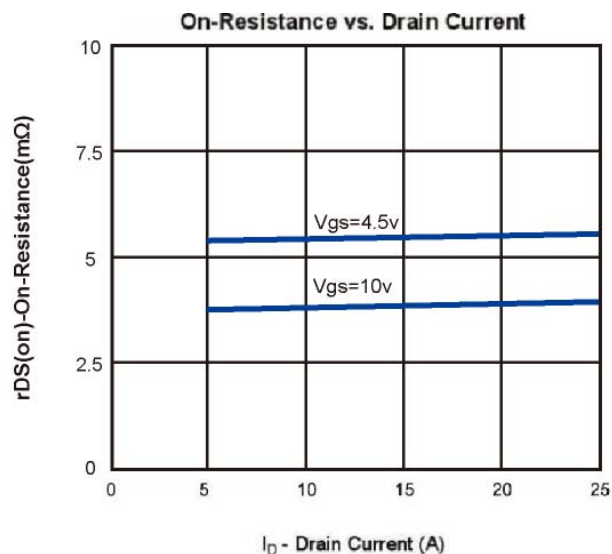
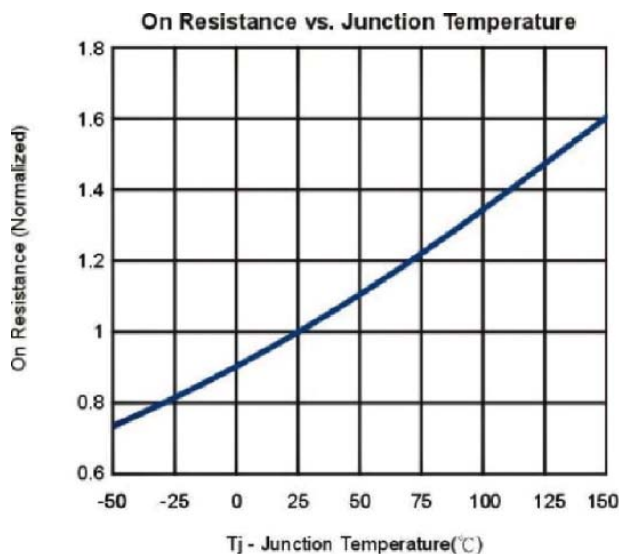
Note: a. Pulse test: pulse width ≤ 300us, duty cycle ≤ 2%, Guaranteed by design, not subject to production testing.

b. Matsuki Electric/ Force mos reserves the right to improve product design, functions and reliability without notice.



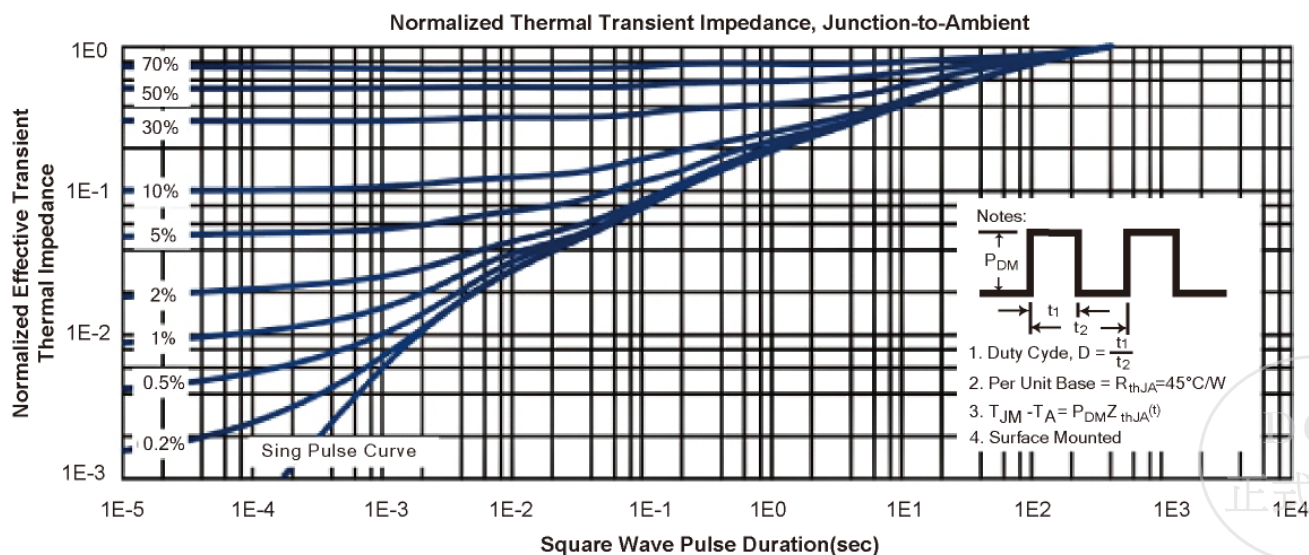
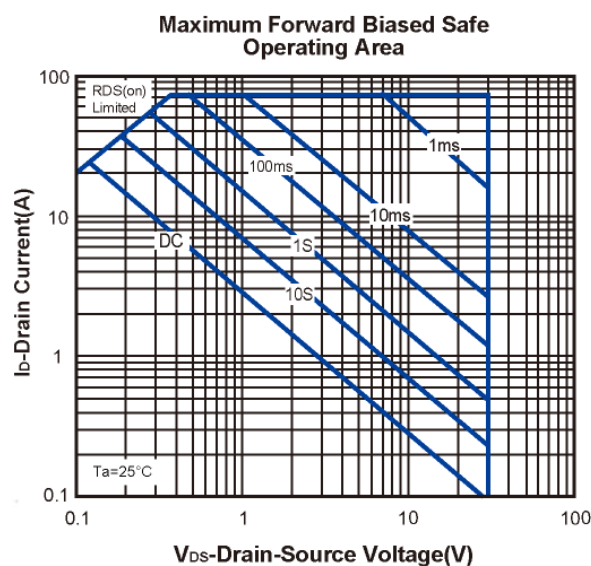
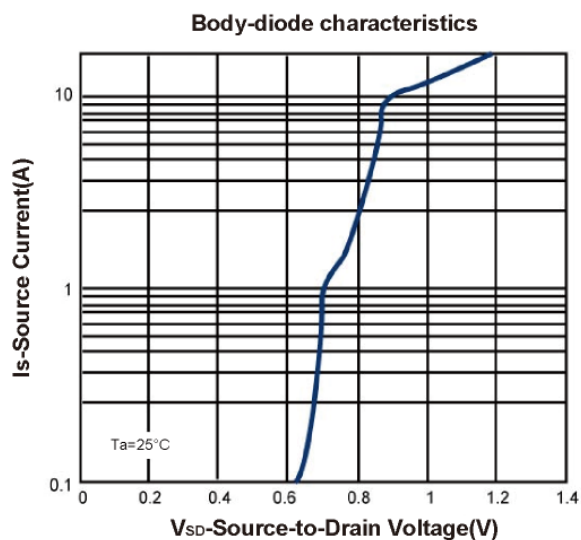
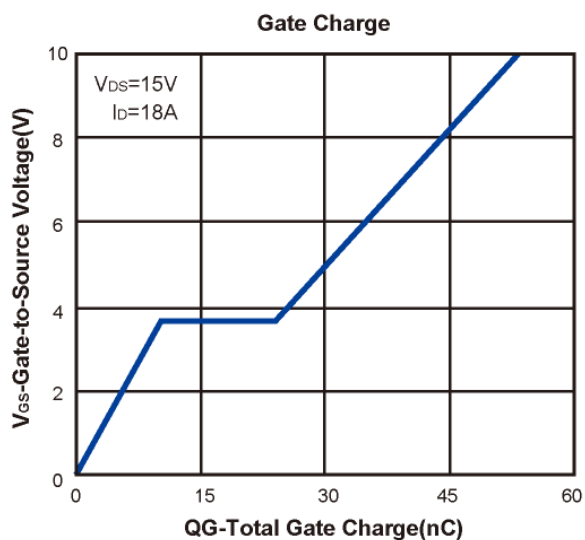
N-Channel 30V (D-S) MOSFET

Typical Characteristics (T_J = 25°C Noted)

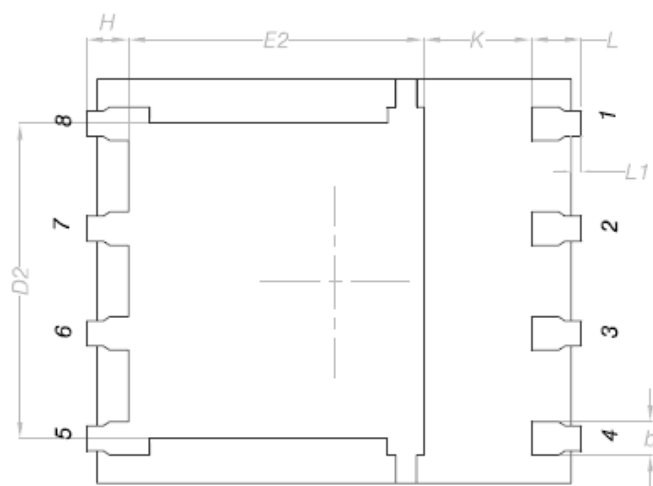


N-Channel 30V (D-S) MOSFET

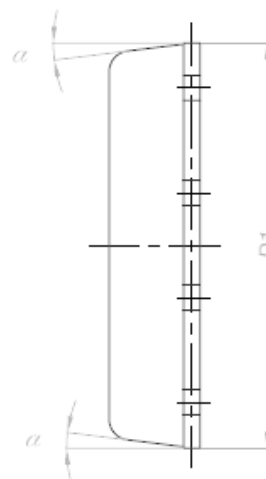
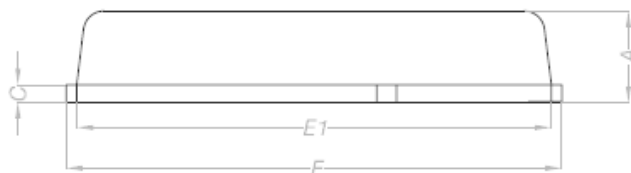
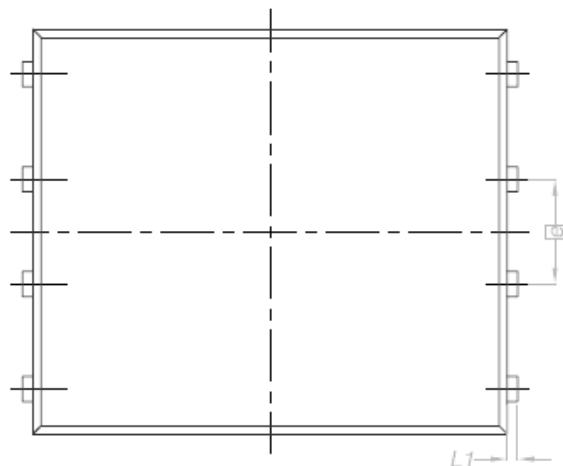
Typical Characteristics (T_J =25°C Noted)



PowerDFN5x6 Package Outline



BACKSIDE VIEW



SYMBOL	MILLIMETERS (mm)	
	MIN	MAX
A	0.90	1.10
b	0.33	0.51
C	0.20	0.30
D1	4.80	5.00
D2	3.61	3.96
E	5.90	6.10
E1	5.70	5.80
E2	3.38	3.78
e	1.27 BSC	
H	0.41	0.61
K	1.10	-
L	0.51	0.71
L1	0.06	0.20
α	0°	12°

DCC
正式発行